

STL50N6F7

N-channel 60 V, 9 mΩ typ., 60 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data

Features

Order code	VDS	R _{DS(on)} max.	ID
STL50N6F7	60 V	11 mΩ	60 A

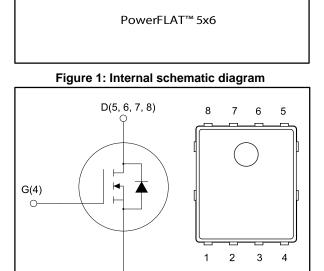
- Among the lowest R_{DS(on)} on the market
- Excellent figure of merit (FoM)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET[™] F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.



S(1, 2, 3)

Table 1: Device summary

Top View

AM15540v2

Order code	Marking	Package	Packaging
STL50N6F7	50N6F7	PowerFLAT [™] 5x6	Tape and reel

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vds	Drain-source voltage	60	V
V _{GS}	Gate-source voltage	± 20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	60	А
ID ⁽¹⁾	Drain current (continuous) at T _c = 100 °C	43	А
I _{DM} ⁽¹⁾⁽²⁾	Drain current (pulsed)	240	А
اD ⁽³⁾	Drain current (continuous) at T _{pcb} = 25 °C	15	А
I _D ⁽³⁾	Drain current (continuous) at T _{pcb} = 100 °C	11	А
I _{DM} ⁽²⁾⁽³⁾	Drain current (pulsed)	60	А
Ртот ⁽¹⁾	Total dissipation at $T_c = 25 \ ^{\circ}C$	71	W
Ртот ⁽³⁾	Total dissipation at $T_{pcb} = 25 \text{ °C}$	4.8	W
Tj	Operating junction temperature	-55 to 175	°C
T _{stg}	Storage temperature	-55 10 175	0

Notes:

 $^{(1)}\mbox{This}$ value is rated according to $R_{\mbox{thj-c}}$

 $^{(2)}\mbox{Pulse}$ width limited by safe operating area

 $^{(3)}\mbox{This}$ value is rated according to $R_{\mbox{thj-pcb}}$

Table	3:	Thermal	data
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Symbol	Parameter	Value	Unit
Rthj-pcb ⁽¹⁾	Thermal resistance junction-pcb max.	31.3	°C/W
R _{thj} -case	Thermal resistance junction-case max.	2.1	°C/W

Notes:

 $^{(1)}\!When$ mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 sec



2 Electrical characteristics

(T_c = 25 °C unless otherwise specified)

Table 4: On/On states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, \text{ V}_{GS} = 0 \text{ V}$	60			V
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V V _{DS} = 60 V			1	μA
I _{GSS}	Gate-body leakage current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		4	V
RDS(on)	Static drain-source on-resistance	V_{GS} = 10 V, I _D = 7.5 A		9	11	mΩ

Table 4: On/Off states

Table 5: Dynamic	C
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1035	I	pF
Coss	Output capacitance	$V_{DS} = 30 V, f = 1 MHz,$	-	450	I	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$		53	-	pF
Qg	Total gate charge	V _{DD} = 30 V, I _D = 15 A,	-	17	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V (see Figure 14: "Test	-	5.7	-	nC
Q _{gd}	Gate-drain charge	circuit for gate charge behavior")	-	5.7	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 30 V, I _D = 7.5 A,	I	14.5	-	ns
tr	Rise time	$R_{G} = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13: "Test circuit for resistive load switching times")	-	15.3	-	ns
td(off)	Turn-off delay time		-	19.4	-	ns
t _f	Fall time		-	8	-	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Vsd ⁽¹⁾	Forward on voltage	I _{SD} = 15 A, V _{GS} = 0 V	-		1.2	V
trr	Reverse recovery time	I _D = 15 A, di/dt = 100 A/µs	-	26.8		ns
Qrr	Reverse recovery charge	V _{DD} = 48 V (see Figure 15: "Test circuit for inductive load	-	14.2		nC
Irrm	Reverse recovery current	switching and diode recovery times"	-	1.06		А

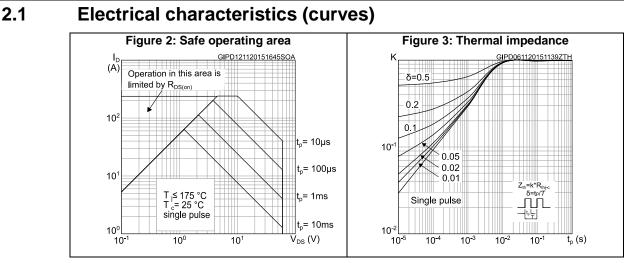
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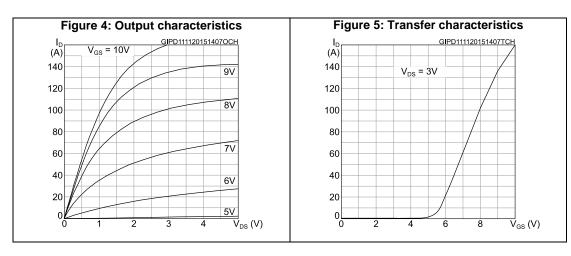
 $^{(1)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5%

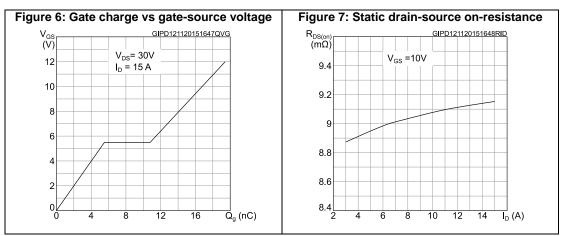




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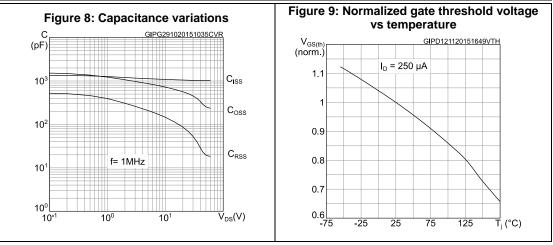


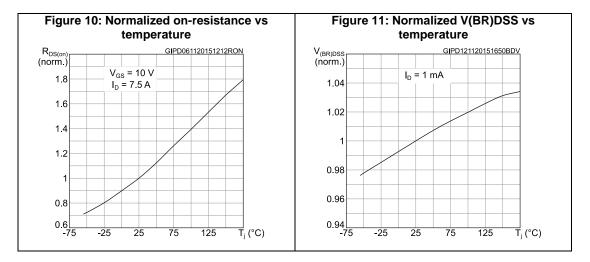


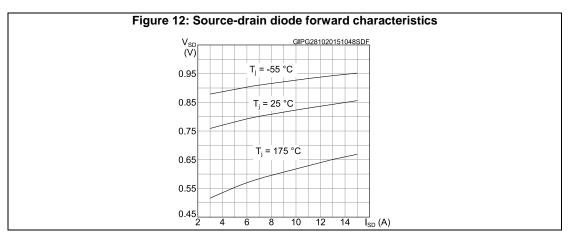
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Electrical characteristics

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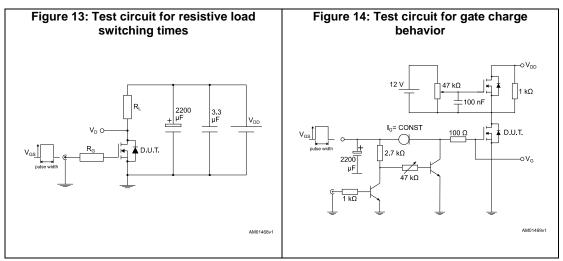


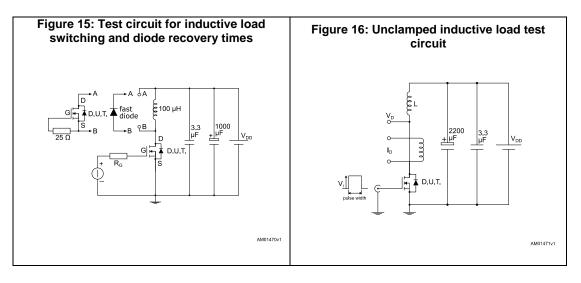
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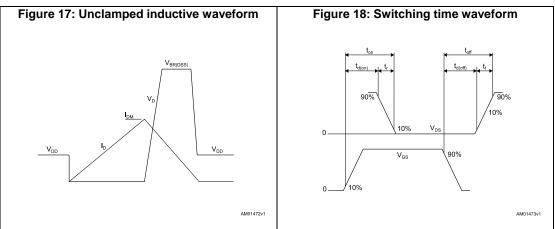


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3 Test circuits







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4 Package mechanical data

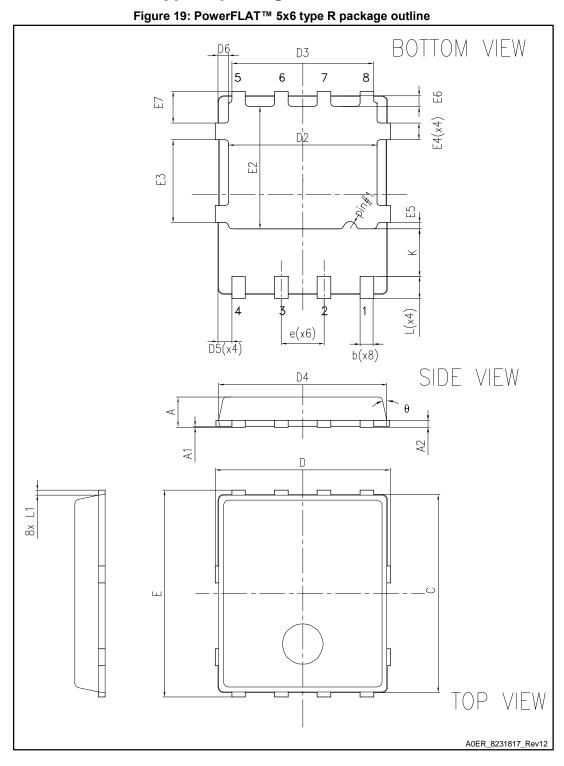
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



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PowerFLAT 5x6 type R package information



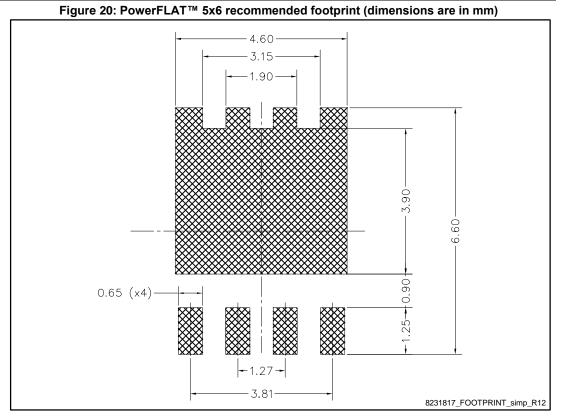
Package mechanical data

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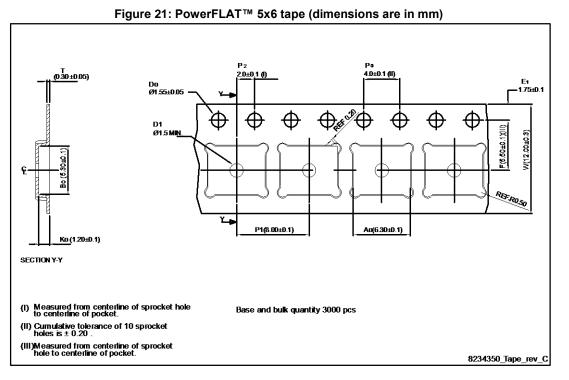
echanical data STL50N6F7					
	Table 8: PowerFLAT™ 5	x6 type R mechanical da	ta		
Dim.	mm				
Dini.	Min.	Тур.	Max.		
А	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
С	5.80	6.00	6.20		
D	5.00	5.20	5.40		
D2	4.15		4.45		
D3	4.05	4.20	4.35		
D4	4.80	5.0	5.20		
D5	0.25	0.4	0.55		
D6	0.15	0.3	0.45		
е		1.27			
E	5.95	6.15	6.35		
E2	3.50		3.70		
E3	2.35		2.55		
E4	0.40		0.60		
E5	0.08		0.28		
E6	0.2	0.325	0.450		
E7	0.75	0.90	1.25		
К	1.275		1.575		
L	0.60		0.80		
L1	0.05	0.15	0.25		
θ	0°		12°		



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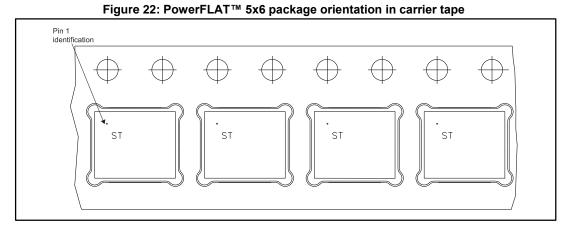


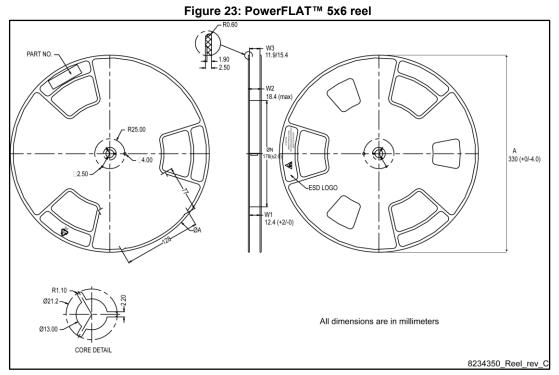
4.2 Packing information



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Package mechanical data





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5 Revision history

Table 9: Document revision history

Date	Revision	Changes
22-Jul-2015	1	First release.
12-Nov-2015	2	Document status promoted from preliminary to production data. Updated title and features in cover page. Updated <i>Table 2: "Absolute maximum ratings"</i> and <i>Section 3:</i> <i>"Electrical characteristics".</i> Added <i>Section 3.1: "Electrical characteristics (curves)"</i> Updated <i>Section 5.1: "PowerFLAT 5x6 type R package information".</i> Minor text changes.



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